

# ADC081C021/ADC081C027 I<sup>2</sup>C-Compatible, 8-Bit Analog-to-Digital Converter (ADC) with Alert Function

## **General Description**

The ADC081C021 is a low-power, monolithic, 8-bit, analog-to-digital converter(ADC) that operates from a +2.7 to 5.5V supply. The converter is based on a successive approximation register architecture with an internal track-and-hold circuit that can handle input frequencies up to 11MHz. The ADC081C021 operates from a single supply which also serves as the reference. The device features an I<sup>2</sup>C-compatible serial interface that operates in all three speed modes, including high speed mode (3.4MHz).

The ADC's Alert feature provides an interrupt that is activated when the analog input violates a programmable upper or lower limit value. The device features an automatic conversion mode, which frees up the controller and I<sup>2</sup>C interface. In this mode, the ADC continuously monitors the analog input for an "out-of-range" condition and provides an interrupt if the measured voltage goes out-of-range.

The ADC081C021 comes in a small TSOT-6 package with an alert output. The ADC081C027 comes in a small TSOT-6 package with an address selection input. The ADC081C027 provides three pin-selectable addresses. Pin-compatible alternatives are available with additional address options.

Normal power consumption using a +3V or +5V supply is 0.26mW or 0.78mW, respectively. The automatic powerdown feature reduces the power consumption to less than 1 $\mu$ W while not converting. Operation over the industrial temperature range of -40°C to +105°C is guaranteed. Their low power consumption and small packages make this family of ADCs an excellent choice for use in battery operated equipment.

The ADC081C021 and ADC081C027 are part of a family of pin-compatible ADCs that also provide 12 and 10 bit resolution. For 12-bit ADCs see the ADC121C021 and ADC121C027. For 10-bit ADCs see the ADC101C021 and ADC101C027.

## **Features**

- I<sup>2</sup>C-Compatible 2-wire Interface which supports standard (100kHz), fast (400kHz), and high speed (3.4MHz) modes
- Extended power supply range (+2.7V to +5.5V)
- Up to four pin-selectable chip addresses
- Out-of-range Alert Function
- Automatic Power-down mode while not converting
- Very small 6-pin TSOT packages
- ±8kV HBM ESD protection (SDA, SCL)

# **Key Specifications**

- Resolution
- Conversion Time 1µs (typ)
   INL & DNL ±0.2 LSB (max)

8 bits; no missing codes

ADC081C027

188.9kSPS (max)

- Throughput Rate
- Power Consumption (at 22kSPS)
  - \_\_\_\_\_ 3V Supply
     0.26 mW (typ)

     \_\_\_\_\_ 5V Supply
     0.78 mW (typ)

# **Applications**

- System Monitoring
- Peak Detection
- Portable Instruments
- Medical Instruments
- Test Equipment

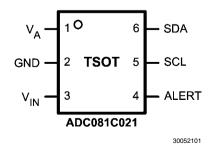
8-bit

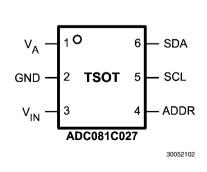
# **Pin-Compatible Alternatives**

,	All devices are fully pin and function compatible.						
	Resolution	ALERT Output	ADDR Input				
	12-bit	ADC121C021	ADC121C027				
	10-bit	ADC101C021	ADC101C027				

ADC081C021

# **Connection Diagrams**



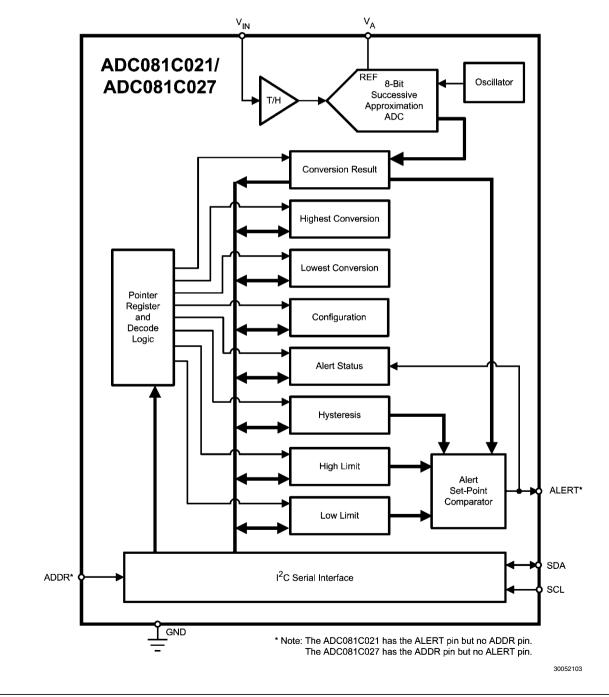


I2C® is a registered trademark of Phillips Corporation.

# **Ordering Information**

Order Code	Option	Package	Top Mark
ADC081C021CIMK	Alert pin	TSOT-6	X34C
ADC081C021CIMKX	Alert pin	TSOT-6 Tape-and-Reel	X34C
ADC081C027CIMK	Address pin	TSOT-6	X35C
ADC081C027CIMKX	Address pin	TSOT-6 Tape-and-Reel	X35C
ADC081C021EB	Shipped with the ADC081C021. Also compatible with the ADC081C027 option. Please order samples.	Evaluation Board	

# **Block Diagram**



Symbol	Туре	Equivalent Circuit	Description
V <sub>A</sub>	Supply		Power and unbufferred reference voltage. $V_A$ must be free of noise and decoupled to GND.
GND	Ground		Ground for all on-chip circuitry.
V <sub>IN</sub>	Analog Input	See Figure 4	Analog input. This signal can range from GND to $V_A$ .
ALERT	Digital Output		Alert output. Can be configured as active high or active low. This is an open drain data line that must be pulled the supply $(V_A)$ with an external pull-up resistor.
SCL	Digital Input	PIN Snap D1 Back	Serial Clock Input. SCL is used together with SDA to control the transfer of data in and out of the device. This an open drain data line that must be pulled to the supp $(V_A)$ with an external pull-up resistor. This pin's extender ESD tolerance( 8kV HBM) allows extension of the I <sup>2</sup> C b across multiple boards without extra ESD protection.
SDA	Digital Input/Output	GND	Serial Data bi-directional connection. Data is clocked in or out of the internal 16-bit register with SCL. This is an open drain data line that must be pulled to the supply $(V_A)$ with an external pull-up resistor. This pin's extender ESD tolerance( 8kV HBM) allows extension of the I <sup>2</sup> C b across multiple boards without extra ESD protection.
ADDR	Digital Input, three levels	PIN D1 2.1k \$41.5k Back \$41.5k	Tri-level Address Selection Input. Sets Bits A0 & A1 of t 7-bit slave address. (see ///)

### VA GND ALERT SCL SDA ADDR V<sub>IN</sub> ADC081C021 1 2 3 4 5 6 N/A TSOT-6 ADC081C027 1 2 3 N/A 5 6 4 TSOT-6

# **Absolute Maximum Ratings**

### (Notes 1, 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage, V <sub>A</sub>	-0.3V to +6.5V
Voltage on any Analog Input Pin to GND	–0.3V to (V <sub>A</sub> +0.3V)
Voltage on any Digital Input Pin to GND	-0.3V to 6.5V
Input Current at Any Pin (Note 3)	±15 mA
Package Input Current (Note 3)	±20 mA
Power Dissipation at $T_A = 25^{\circ}C$	See (Note 4)
ESD Susceptibility (Note 5) VA, GND, VIN, ALERT, ADDR pins:	
Human Body Model	2500V
Machine Model	250V
Charged Device Model (CDM) SDA, SCL pins:	1250V
Human Body Model	8000V
Machine Model	400V
Junction Temperature	+150°C
Storage Temperature	–65°C to +150°C

# Operating Ratings (Notes 1, 2)

Operating Temperature Range	$-40^{\circ}C \le T_A \le +105^{\circ}C$
Supply Voltage, V <sub>A</sub>	+2.7V to 5.5V
Analog Input Voltage, V <sub>IN</sub>	0V to V <sub>A</sub>
Digital Input Voltage (Note 7)	0V to 5.5V
Sample Rate	up to 188.9 kSPS

# Package Thermal Resistances

Package	θ <sub>JA</sub>	
6-Lead TSOT	250°C/W	

Soldering process must comply with National Semiconductor's Reflow Temperature Profile specifications. Refer to www.national.com/packaging. (Note 6)

# **Electrical Characteristics**

The following specifications apply for  $V_A = +2.7V$  to +5.5V, GND = 0V,  $f_{SCL}$  up to 3.4MHz,  $f_{IN} = 1$ kHz for  $f_{SCL}$  up to 400kHz,  $f_{IN} = 10$ kHz for  $f_{SCL} = 3.4$ MHz unless otherwise noted. **Boldface limits apply for T\_A = T\_{MIN} to T\_{MAX}: all other limits T\_A = 25^{\circ}C unless otherwise noted.** 

Symbol	Parameter	Conditions	Typical (Note 9)	Limits (Note 9)	Units (Limits)
STATIC CO	ONVERTER CHARACTERISTICS				
	Resolution with No Missing Codes			8	Bits
	Interval New Lincovity (End Deint	V <sub>A</sub> = +2.7V to +3.6V	±0.04	±0.2	LSB (max)
INL	Integral Non-Linearity (End Point Method)	$V_A = +2.7V$ to +5.5V. $f_{SCL}$ up to 400kHz (Note 13)	±0.1	±0.25	LSB (max)
		V <sub>A</sub> = +2.7V to +3.6V	+0.04	±0.2	LSB (max)
DNL	Differential Non-Linearity	$V_{A} = +2.7V$ to +5.5V. $f_{SCL}$ up to 400kHz (Note 13)	±0.08	±0.25	LSB (max)
		$V_{A} = +2.7V \text{ to } +3.6V$	+0.26	±0.5	LSB (max)
$V_{OFF}$	Offset Error	$V_{A} = +2.7V$ to +5.5V. f <sub>SCL</sub> up to 400kHz (Note 13)	+0.25	±0.5	LSB (max)
GE	Gain Error		-0.01	±0.4	LSB (max)
DYNAMIC	CONVERTER CHARACTERISTICS				
ENOB	Effective Number of Bits		7.98	7.8	Bits (min)
SNR	Signal-to-Noise Ratio		49.8	49	dB (min)
THD	Total Harmonic Distortion		-70.6	-64	dB (max)
SINAD	Signal-to-Noise Plus Distortion Ratio		49.8	49	dB (min)
SFDR	Spurious-Free Dynamic Range		-68.8	65	dB (min)
IMD	Intermodulation Distortion, Second Order Terms (IMD <sub>2</sub> )	V <sub>A</sub> = +3.0V, f <sub>a</sub> = 1.035 kHz, f <sub>b</sub> = 1.135 kHz	-75.5		dB
	Intermodulation Distortion, Third Order Terms ( $IMD_3$ )	V <sub>A</sub> = +3.0V, f <sub>a</sub> = 1.035 kHz, f <sub>b</sub> = 1.135 kHz	-71.8		dB
		V <sub>A</sub> = +3.0V	8		MHz
FPBW	Full Power Bandwidth (-3dB)	V <sub>A</sub> = +5.0V	11		MHz

Symbol	Parameter	Conditions	Typical (Note 9)	Limits (Note 9)	Units (Limits
ANALOG	INPUT CHARACTERISTICS	·			
V <sub>IN</sub>	Input Range		0 to V <sub>A</sub>		V
I <sub>DCL</sub>	DC Leakage Current (Note 10)			±1	μA (max)
		Track Mode	30		pF
C <sub>INA</sub>	Input Capacitance	Hold Mode	3		pF
SERIAL IN	ITERFACE INPUT CHARACTERIS	STICS (SCL, SDA)			
V <sub>IH</sub>	Input High Voltage			0.7 x V <sub>A</sub>	V (min)
V <sub>IL</sub>	Input Low Voltage			0.3 x V <sub>A</sub>	V (max)
I <sub>IN</sub>	Input Current (Note 10)			±1	µA (max)
C <sub>IN</sub>	Input Pin Capacitance		3		pF
V <sub>HYST</sub>	Input Hysteresis			0.1 x V <sub>A</sub>	V (min)
	SELECTION INPUT CHARACTE	RISTICS (ADDR)	•		•
V <sub>IH</sub>	Input High Voltage			V <sub>A</sub> - 0.5V	V (min)
V <sub>IL</sub>	Input Low Voltage			0.5	V (max)
I <sub>IN</sub>	Input Current (Note 10)			±1	μA (max)
OGIC OL	JTPUT CHARACTERISTICS, OPE	N-DRAIN (SDA, ALERT)			-
N/		I <sub>SINK</sub> = 3 mA		0.4	V (max)
V <sub>OL</sub>	Output Low Voltage	I <sub>SINK</sub> = 6 mA		0.6	V (max)
I <sub>oz</sub>	High-Impedence Output Leakage Current (Note 10)			±1	µA (max)
	Output Coding		Str	aight (Natura	l) Binary

Symbol	Parameter	Conc	litions	Typical (Note 9)	Limits (Note 9)	Units (Limits
POWER R	EQUIREMENTS			ŕ_Į	. ,	1
V	Supply Voltage Minimum				2.7	V (min)
V <sub>A</sub>	Supply Voltage Maximum				5.5	V (max)
Continuous	s Operation Mode 2-wire interfa	ice active.		-		
		f <sub>SCL</sub> =400kHz	$V_{A} = 2.7V \text{ to } 3.6V$	0.08	0.14	mA (max)
	Supply Current	ISCL-400KI12	$V_{A} = 4.5V$ to 5.5V	0.16	0.30	mA (max)
I <sub>N</sub>	Supply Current		$V_{A} = 2.7V \text{ to } 3.6V$	0.37	0.55	mA (max)
		f <sub>SCL</sub> =3.4MHz	$V_{A} = 4.5V$ to 5.5V	0.74	0.99	mA (max)
		f 400kH=	V <sub>A</sub> = 3.0V	0.26		mW
Р	N Power Consumption	f <sub>SCL</sub> =400kHz	V <sub>A</sub> = 5.0V	0.78		mW
P <sub>N</sub>			V <sub>A</sub> = 3.0V	1.22		mW
		f <sub>SCL</sub> =3.4MHz	V <sub>A</sub> = 5.0V	3.67		mW
Automatic	Conversion Mode 2-wire interfa	ace stopped and quiet (SC	L = SDA = V <sub>A</sub> ). f <sub>SAMPL</sub>	E = T <sub>CONVEF</sub>	<sub>RT</sub> * 32	•
			$V_{A} = 2.7V \text{ to } 3.6V$	0.41	0.59	mA (max)
I <sub>A</sub>	Supply Current		$V_{A} = 4.5V$ to 5.5V	0.78	1.2	mA (max)
	Power Consumption		V <sub>A</sub> = 3.0V	1.35		mW
P <sub>A</sub>			$V_{A} = 5.0V$	3.91		mW
Power Dov	vn Mode (PD <sub>1</sub> ) 2-wire interface	stopped and quiet. (SCL :	= SDA = V <sub>A</sub> ).(Note 10)	I		•
I <sub>PD1</sub>	Supply Current			0.1	0.2	μA (max)
P <sub>PD1</sub>	Power Consumption			0.5	0.9	µW (max)
	vn Mode (PD <sub>2</sub> ) 2-wire interface	active. Master communica	ating with a different d	evice on the	bus.	
			$V_{A} = 2.7V \text{ to } 3.6V$	13	45	μA (max)
		f <sub>SCL</sub> =400kHz	$V_{A} = 4.5V \text{ to } 5.5V$	27	80	μA (max)
I <sub>PD2</sub>	Supply Current		$V_{A} = 2.7V \text{ to } 3.6V$	89	150	μA (max)
		f <sub>SCL</sub> =3.4MHz	$V_{A} = 4.5V \text{ to } 5.5V$	168	250	μA (max)
			V <sub>A</sub> = 3.0V	0.04		mW
		f <sub>SCL</sub> =400kHz	$V_A = 5.0V$	0.14		mW
P <sub>PD2</sub>	Power Consumption		$V_A = 3.0V$	0.29		mW
	f <sub>sci</sub>	f <sub>SCL</sub> =3.4MHz	$V_A = 5.0V$	0.84		mW

# A.C. and Timing Characteristics

The following specifications apply for  $V_A = +2.7V$  to +5.5V. Boldface limits apply for  $T_{MIN} \le T_A \le T_{MAX}$  and all other limits are at  $T_A = 25^{\circ}$ C, unless otherwise specified.

Symbol	Parameter	Conditions (Note 12)	<b>Typical</b> (Note 9)	Limits (Notes 9, 12)	Units (Limits)
CONVER				1	
	Conversion Time	(	1		μs
		f <sub>SCL</sub> = 100kHz	5.56		kSPS
f <sub>CONV</sub>	Conversion Rate	f <sub>SCL</sub> = 400kHz	22.2		kSPS
CONV		f <sub>SCL</sub> = 1.7MHz	94.4		kSPS
		f <sub>SCL</sub> = 3.4MHz	188.9		kSPS
DIGITAL	TIMING SPECS (SCL, SDA)				
f <sub>SCL</sub>	Serial Clock Frequency	Standard Mode Fast Mode High Speed Mode, $C_b = 100 pF$ High Speed Mode, $C_b = 400 pF$		100 400 3.4 1.7	kHz (max) kHz (max) MHz (max) MHz (max)
t <sub>LOW</sub>	SCL Low Time	Standard Mode Fast Mode High Speed Mode, $C_b = 100pF$ High Speed Mode, $C_b = 400pF$		4.7 1.3 160 320	us (min) us (min) ns (min) ns (min)
t <sub>ніGH</sub>	SCL High Time	Standard Mode Fast Mode High Speed Mode, $C_b = 100pF$ High Speed Mode, $C_b = 400pF$		4.0 0.6 60 120	us (min) us (min) ns (min) ns (min)
t <sub>SU;DAT</sub>	Data Setup Time	Standard Mode Fast Mode High Speed Mode		250 100 10	ns (min) ns (min) ns (min)
		Standard Mode (Note 14)		0 3.45	us (min) us (max)
t	Data Hold Time	Fast Mode (Note 14)		0 0.9	us (min) us (max)
t <sub>HD;DAT</sub>		High Speed Mode, C <sub>b</sub> = 100pF		0 70	ns (min) ns (max)
		High Speed Mode, C <sub>b</sub> = 400pF		0 150	ns (min) ns (max)
t <sub>su;sta</sub>	Setup time for a start or a repeated start condition	Standard Mode Fast Mode High Speed Mode		4.7 0.6 160	us (min) us (min) ns (min)
t <sub>HD;STA</sub>	Hold time for a start or a repeated start condition	Standard Mode Fast Mode High Speed Mode		4.0 0.6 160	us (min) us (min) ns (min)
t <sub>BUF</sub>	Bus free time between a stop and start condition	Standard Mode Fast Mode		4.7 1.3	us (min) us (min)
t <sub>su;sto</sub>	Setup time for a stop condition	Standard Mode Fast Mode High Speed Mode		4.0 0.6 160	us (min) us (min) ns (min)

2
0
C
Ť
œ
0
Õ
ŏ
₹
-
-
2
0
C
Ť
œ
õ
Õ
Ď
4

Symbol	Parameter	Conditions (Note 12)	<b>Typical</b> (Note 9)	Limits (Notes 9, 12)	Units (Limits)
	Rise time of SDA signal	Standard Mode		1000	ns (max)
		Fast Mode		20+0.1C <sub>b</sub> 300	ns (min) ns (max)
t <sub>rDA</sub>		High Speed Mode, C <sub>b</sub> = 100pF		10 80	ns (max) ns (min) ns (max)
		High Speed Mode, C <sub>b</sub> = 400pF		20 160	ns (min) ns (max)
		Standard Mode		250	ns (max)
		Fast Mode		20+0.1C <sub>b</sub> 250	ns (min) ns (max)
t <sub>fDA</sub> Fall time of SDA signal	Fall time of SDA signal	High Speed Mode, C <sub>b</sub> = 100pF		10 80	ns (min) ns (max)
		High Speed Mode, C <sub>b</sub> = 400pF		20 160	ns (min) ns (max)
	Rise time of SCL signal	Standard Mode		1000	ns (max)
t <sub>rcL</sub> R		Fast Mode		20+0.1C <sub>b</sub> 300	ns (min) ns (max)
		High Speed Mode, C <sub>b</sub> = 100pF		10 40	ns (min) ns (max)
		High Speed Mode, C <sub>b</sub> = 400pF		20 80	ns (min) ns (max)
		Standard Mode		1000	ns (max)
	Rise time of SCL signal after a	Fast Mode		20+0.1C <sub>b</sub> 300	ns (min) ns (max)
t <sub>rCL1</sub>	repeated start condition and after an acknowledge bit.	High Speed Mode, C <sub>b</sub> = 100pF		10 80	ns (min) ns (max)
		High Speed Mode, C <sub>b</sub> = 400pF		20 160	ns (min) ns (max)
		Standard Mode		300	ns (max)
		Fast Mode		20+0.1C <sub>b</sub> 300	ns (min) ns (max)
Fall time of a SCL signal	Fall time of a SCL signal	High Speed Mode, C <sub>b</sub> = 100pF		10 40	ns (min) ns (max)
		High Speed Mode, C <sub>b</sub> = 400pF		20 80	ns (min) ns (max)
C <sub>b</sub>	Capacitive load for each bus line (SCL and SDA)			400	pF (max)
SP	Pulse Width of spike suppressed (Note 11)	Fast Mode High Speed Mode		50 10	ns (max) ns (max)

**Note 1:** Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions. Operation of the device beyond the maximum Operating Ratings is not recommended.

Note 2: All voltages are measured with respect to GND = 0V, unless otherwise specified.

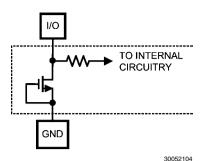
Note 3: When the input voltage at any pin exceeds 5.5V or is less than GND, the current at that pin should be limited per the Absolute Maximum Ratings. The mximum package input current rating limits the number of pins that can safely exceed the power supplies.

**Note 4:** The absolute maximum junction temperature ( $T_Jmax$ ) for this device is 150°C. The maximum allowable power dissipation is dictated by  $T_Jmax$ , the junction-to-ambient thermal resistance ( $\theta_{JA}$ ), and the ambient temperature ( $T_A$ ), and can be calculated using the formula  $P_DMAX = (T_Jmax - T_A) / \theta_{JA}$ . The values for maximum power dissipation will be reached only when the device is operated in a severe fault condition (e.g., when input or output pins are driven beyond the operating ratings, or the power supply polarity is reversed).

**Note 5:** Human body model is a 100 pF capacitor discharged through a  $1.5 \text{ k}\Omega$  resistor. Machine model is a 220 pF capacitor discharged through 0  $\Omega$ . Charged device model simulates a pin slowly acquiring charge (such as from a device sliding down the feeder in an automated assembler) then rapidly being discharged. **Note 6:** Reflow temperature profiles are different for lead-free packages.

www.national.com

Note 7: The inputs are protected as shown below. Input voltage magnitudes up to 5.5V, regardless of V<sub>A</sub>, will not cause errors in the conversion result. For example, if V<sub>A</sub> is 3V, the digital input pins can be driven with a 5V logic device.



Note 8: To guarantee accuracy, it is required that  $V_{\text{A}}$  be well by passed and free of noise.

Note 9: Typical figures are at T<sub>J</sub> = 25°C, and represent most likely parametric norms. Test limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

Note 10: This parameter is guaranteed by design and/or characterization and is not tested in production.

**Note 11:** Spike suppression filtering on SCL and SDA will supress spikes that are less than 50ns for standard and fast modes, and less than 10ns for hs-mode. **Note 12:** C<sub>h</sub> refers to the capacitance of one bus line. C<sub>h</sub> is expressed in pF units.

Note 13: The ADC will meet Minimum/Maximum specifications for  $f_{SCL}$  up to 3.4MHz and  $V_A = 2.7V$  to 3.6V when operating in the Quiet Interface Mode (Section 1.11).

Note 14: The ADC081C021 will provide a minimum data hold time of 300ns to comply with the I<sup>2</sup>C Specification.

# **Timing Diagrams**

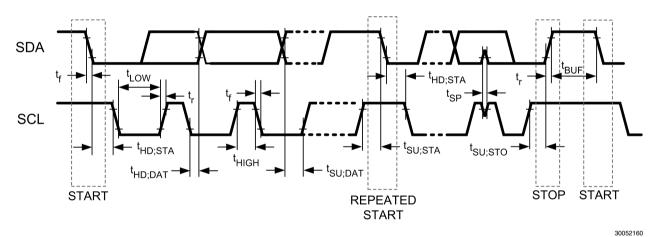


FIGURE 1. Serial Timing Diagram

# **Specification Definitions**

**ACQUISITION TIME** is the time required for the ADC to acquire the input voltage. During this time, the hold capacitor is charged by the input voltage.

**APERTURE DELAY** is the time between the start of a conversion and the time when the input signal is internally acquired or held for conversion.

**CONVERSION TIME** is the time required, after the input voltage is acquired, for the ADC to convert the input voltage to a digital word.

**DIFFERENTIAL NON-LINEARITY (DNL)** is the measure of the maximum deviation from the ideal step size of 1 LSB.

**EFFECTIVE NUMBER OF BITS (ENOB, or EFFECTIVE BITS)** is another method of specifying Signal-to-Noise and Distortion or SINAD. ENOB is defined as (SINAD - 1.76) / 6.02 and says that the converter is equivalent to a perfect ADC of this (ENOB) number of bits.

**FULL POWER BANDWIDTH** is a measure of the frequency at which the reconstructed output fundamental drops 3 dB below its low frequency value for a full scale input.

**GAIN ERROR** is the deviation of the last code transition (111...110) to (111...111) from the ideal ( $V_{REF}$  - 1.5 LSB), after adjusting for offset error.

**INTEGRAL NON-LINEARITY (INL)** is a measure of the deviation of each individual code from a line drawn from negative full scale ( $\frac{1}{2}$  LSB below the first code transition) through positive full scale ( $\frac{1}{2}$  LSB above the last code transition). The deviation of any given code from this straight line is measured from the center of that code value.

**INTERMODULATION DISTORTION (IMD)** is the creation of additional spectral components as a result of two sinusoidal frequencies being applied to an individual ADC input at the same time. It is defined as the ratio of the power in either the second or the third order intermodulation products to the sum of the power in both of the original frequencies. Second order products are  $f_a \pm f_b$ , where  $f_a$  and  $f_b$  are the two sine wave input frequencies. Third order products are  $(2f_a \pm f_b)$  and  $(f_a \pm 2f_b)$ . IMD is usually expressed in dB.

**MISSING CODES** are those output codes that will never appear at the ADC output. The ADC081C021 is guaranteed not to have any missing codes.

**OFFSET ERROR** is the deviation of the first code transition (000...000) to (000...001) from the ideal (i.e. GND + 0.5 LSB).

**SIGNAL TO NOISE RATIO (SNR)** is the ratio, expressed in dB, of the rms value of the input signal to the rms value of the sum of all other spectral components below one-half the sampling frequency, not including harmonics or d.c.

**SIGNAL TO NOISE PLUS DISTORTION (S/N+D or SINAD)** Is the ratio, expressed in dB, of the rms value of the input signal to the rms value of all of the other spectral components below half the clock frequency, including harmonics but excluding d.c.

**SPURIOUS FREE DYNAMIC RANGE (SFDR)** is the difference, expressed in dB, between the desired signal amplitude to the amplitude of the peak spurious spectral component, where a spurious spectral component is any signal present in the output spectrum that is not present at the input and may or may not be a harmonic.

**TOTAL HARMONIC DISTORTION (THD)** is the ratio, expressed in dBc, of the rms total of the first n harmonic components at the output to the rms level of the input signal frequency as seen at the output. THD is calculated as

THD = 20 x log<sub>10</sub> 
$$\sqrt{\frac{A_{f2}^2 + \dots + A_{Fn}^2}{A_{f1}^2}}$$

where  $A_{f1}$  is the RMS power of the input frequency at the output and  $A_{f2}$  through  $A_{fn}$  are the RMS power in the first n harmonic frequencies.

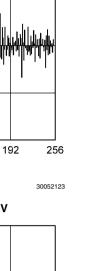
**THROUGHPUT TIME** is the minimum time required between the start of two successive conversions. It is the acquisition time plus the conversion time.

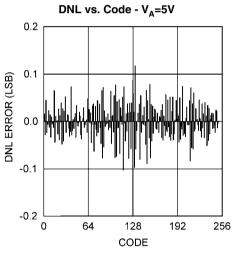
LEAST SIGNIFICANT BIT (LSB) is the bit that has the smallest value or weight of all bits in a word. This value is

$$LSB = V_A / 2^n$$

where  $V_A$  is the supply voltage for this product, and "n" is the resolution in bits, which is 8 for the ADC081C021.

**MOST SIGNIFICANT BIT (MSB)** is the bit that has the largest value or weight of all bits in a word. Its value is 1/2 of V<sub>A</sub>.





### DNL vs. Supply 0.2 0.1 DNL ERROR (LSB) +DNL 0.0 -DNL -0.1 -0.2 ∟ 2.5 3.0 3.5 4.5 5.0 5.5 4.0 $V_A(V)$

30052127

30052125

# **Typical Performance Characteristics** $f_{SCL} = 400$ kHz, $f_{SAMPLE} = 22$ kSPS, $f_{IN} = 1$ kHz, $V_A = 5.0$ V, $T_A = +25^{\circ}$ C, unless otherwise stated.

DNL vs. Code - V<sub>A</sub>=3V

0.2

0.1

0.0

-0.1

-0.2

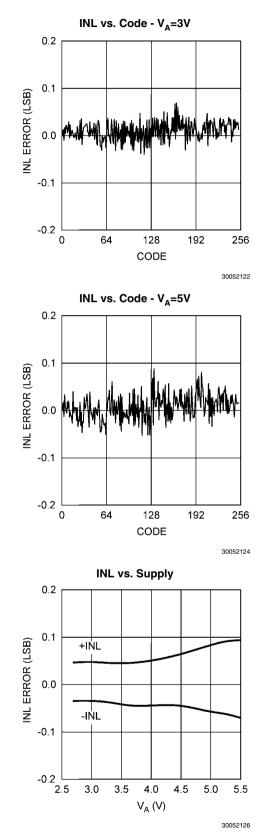
0

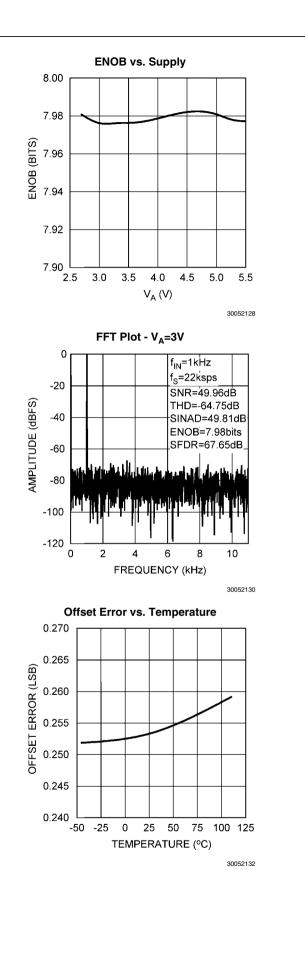
64

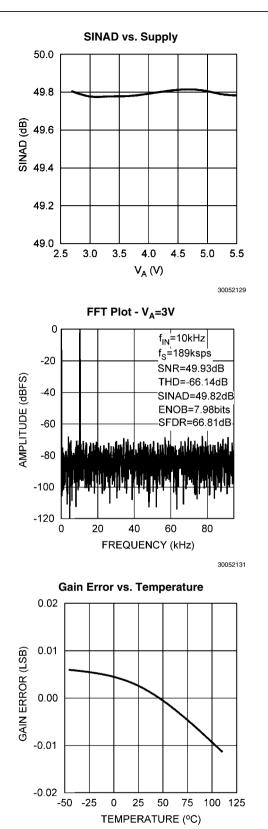
128

CODE

DNL ERROR (LSB)

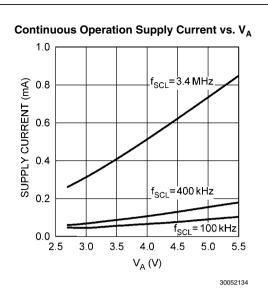




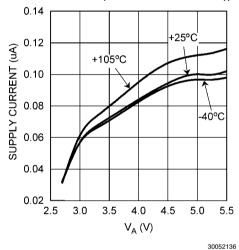


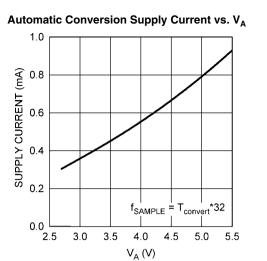
30052133





Power Down (PD<sub>1</sub>) Supply Current vs. V<sub>A</sub>





30052135

# **1.0 Functional Description**

The ADC081C021 is a successive-approximation analog-todigital converter designed around a charge-redistribution digital-to-analog converter. Unless otherwise stated, references to the ADC081C021 in this section will apply to both the ADC081C021 and the ADC081C027.

### **1.1 CONVERTER OPERATION**

Simplified schematics of the ADC081C021 in both track and hold operation are shown in *Figure 2* and *Figure 3* respectively. In *Figure 2*, the ADC081C021 is in track mode; switch SW1 connects the sampling capacitor to the analog input channel, and SW2 equalizes the comparator inputs. The ADC is in this state for approximately 0.4µs at the beginning of every conversion cycle. Conversions occur when the conversion result register is read by the I<sup>2</sup>C controller and when the ADC is in automatic conversion mode. (see Section 1.9)

*Figure 3* shows the ADC081C021 in hold mode: switch SW1 connects the sampling capacitor to ground and switch SW2 unbalances the comparator. The control logic then instructs the charge-redistribution DAC to add or subtract fixed amounts of charge to or from the sampling capacitor until the comparator is balanced. When the comparator is balanced, the digital word supplied to the DAC is also the digital representation of the analog input voltage. This digital word is stored in the conversion result register and read via the 2-wire interface.

### **1.2 ANALOG INPUT**

An equivalent circuit for the input of the ADC081C021 is shown in *Figure 4*. Diodes D1 and D2 provide ESD protection for the analog input. The operating range for the analog input is 0 V to  $V_A$ . Going beyond this range will cause the ESD diodes to conduct and result in erratic operation.

The capacitor C1 in *Figure 4* has a typical value of 3 pF and is mainly the package pin capacitance. Resistor R1 is the on resistance ( $R_{ON}$ ) of the multiplexer and track / hold switch and is typically 500 $\Omega$ . Capacitor C2 is the ADC081C021 sampling capacitor, and is typically 30 pF. The ADC081C021 will deliver best performance when driven by a low-impedance source (less than 100 $\Omega$ ). This is especially important when using the ADC081C021 to sample dynamic signals. The dynamic performance of the ADC will be affected significantly by large source impedances. An input buffer amplifier may be necessary to limit source impedance. A high-accuracy opamp is recommended to maximize circuit performance. Also important when sampling dynamic signals is an anti-aliasing band-pass or low-pass filter which reduces harmonics and noise at the input.

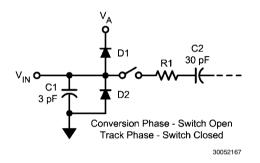


FIGURE 4. Equivalent Input Circuit

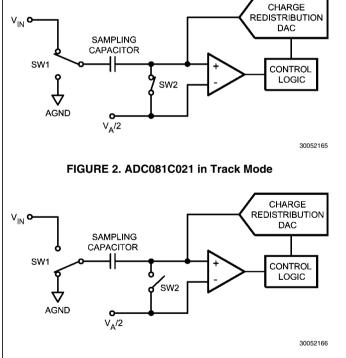


FIGURE 3. ADC081C021 in Hold Mode

### **1.3 ADC TRANSFER FUNCTION**

The output format of the ADC081C021 is straight binary. Code transitions occur midway between successive integer LSB values. The LSB width for the ADC081C021 is  $V_A$  / 256. The ideal transfer characteristic is shown in *Figure 5*. The transition from an output code of 0000 0000 0000 to a code of 0000 0000 0001 is at 1/2 LSB, or a voltage of  $V_A$  / 512. Other code transitions occur at intervals of 1 LSB.

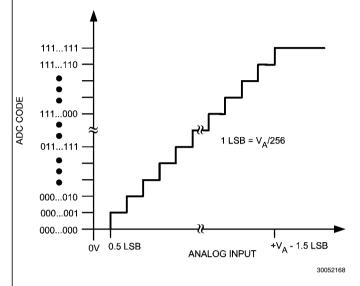


FIGURE 5. Ideal Transfer Characteristic

### **1.4 REFERENCE VOLTAGE**

The ADC081C021 uses the supply  $(V_A)$  as the reference. With that said,  $V_A$  must be treated as a reference. The analogto-digital conversion will only be as precise as the reference  $(V_A)$ . Therefore, the reference  $(V_A)$  should be free of noise. It is also recommended that the reference be driven by a voltage source with low output impedance.

The Applications section provides recommended ways to drive the reference (V\_A) appropriately. Refer to Section 2.1 for details.

### **1.5 POWER-ON RESET**

The power-on reset (POR) state is the point at which the supply voltage rises above the power-on reset threshold, generating an internal reset. Each of the registers contains a defined value upon POR and this data remains there until any of the following occurs:

- The first conversion is completed, causing the Conversion Result Register and various status registers to be updated internally.
- The master writes a different data word to any of the writeable registers.
- The ADC is powered down.

When resetting the device, it is crutial that the  $V_A$  supply be lowered to a maximum of 200mV before the supply is raised again to power-up the device. Dropping the supply to within 200mV of GND during a reset will ensure the ADC performs as specified.

### **1.6 INTERNAL REGISTERS**

The ADC081C021 is equipped with 8 internal data registers and one address pointer register. The registers provide additional ADC functions such as storing minimum and maximum conversion results, setting alert threshold levels, and storing data to configure the operation of the device. *Figure 6* shows all of the registers and their corresponding address pointer values. All of the registers are read/write capable except the conversion result register which is read-only.

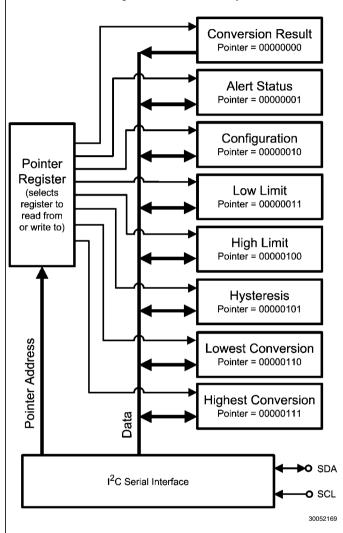


FIGURE 6. Register Structure

### 1.6.1 Address Pointer Register

The address pointer register controls which of the data registers is accessed by the I<sup>2</sup>C interface. The first data byte of every write operation is stored in the address pointer register. This value selects the register that the following data bytes will be written to or read from. Only the three LSBs of this register are relevant. The other bits must always be written as zeros. After a power-on reset, the pointer register defaults to all zeros (conversion result register).

Default Value: 00h

P7	P6	P5	P4	P3	P2	P1	P0
0	0	0	0 0 Register Select				
P2	P1	P0	REGISTER				
0	0	0	Co	nversior	n Result	(read o	nly)
0	0	1		Alert Sta	atus (rea	ad/write)	
0	1	0	Configuration (read/write)				
0	1	1	Low Limit (read/write)				
1	0	0	High Limit (read/write)				
1	0	1	Hysteresis (read/write)				
1	1	0	Lowest Conversion (read/write)				
1	1	1	High	nest Cor	version	(read/w	/rite)

### 1.6.2 Conversion Result Register

Pointer Address 00h (Read Only)

Default Value: 0000h

D15	D14	D13	D12	D11	D10	D9	D8	
Alert Flag		Reserved		Conversion Result[7:4]				
	-			-				
D7	D6	D5	D4	D3	D2	D1	D0	
Conversion Result[3:0]					Rese	nund		

Bits	Name	Description
15	Alert Flag	When the Alert Bit Enable is set in the Configuration Register, this bit will be high if either alert flag is set in the Alert Status Register. Otherwise, this bit is a zero. This bit indicates that an alert condition has occured. The I <sup>2</sup> C controller will typically read the Alert Status register and other data registers to determine the source of the alert.
14:12	Reserved	Always reads zeros.
11:4	Conversion Result	The Analog-to-Digital conversion result. The Conversion result data is a 8-bit data word in straight binary format. The MSB is D11.
3:0	Reserved	Always reads zeros.

### 1.6.3 Alert Status Register

Pointer Address 01h (Read/Write)

Default Value: 00h

D7	D6	D5	D4	D3	D2	D1	D0
	Reserved						
						Alert	Alert

Bits	Name	Description
7:2	Reserved	Always reads zeros. Zeros must be written to these bits.
1	Over Range Alert Flag	Bit is set to 1 when the measured voltage exceeds the $V_{HIGH}$ limit stored in the programmable $V_{HIGH}$ limit register. Flag is reset to 0 when one of the following two conditions is met: (1) The controller writes a one to this bit. (2) The measured voltage decreases below the programmed $V_{HIGH}$ limit minus the programmed $V_{HYST}$ value (See <i>Figure 9</i> ). The alert will only self-clear if the Alert Hold bit is cleared in the Configuration register. If the Alert Hold bit is set, the only way to clear an over range alert is to write a one to this bit.
0	Under Range Alert Flag	Bit is set to 1 when the measured voltage falls below the $V_{LOW}$ limit stored in the programmable $V_{LOW}$ limit register. Flag is reset to 0 when one of the following two conditions is met: (1) The controller writes a one to this bit. (2) The measured voltage increases above the programmed $V_{LOW}$ limit plus the programmed $V_{HYST}$ value. The alert will only self-clear if the Alert Hold bit is cleared in the Configuration register. If the Alert Hold bit is set, the only way to clear an under range alert is to write a one to this bit.

### 1.6.4 Configuration Register

Pointer Address 02h (Read/Write)

### Default Value: 00h

D7	D6	D5	D4	D3	D2	D1	D0
Cycle Time [2:0]		Alert	Alert	Alert	0	Polarity	
		Hold Flag Pin					
				Enable	Enable		

Сус	Cycle Time[2:0]		e[2:0] Conversion	
D7	D6	D5	Interval	f <sub>convert</sub> (kSPS)
0	0	0	Mode Disabled	0
0	0	1	T <sub>convert</sub> x 32	27
0	1	0	T <sub>convert</sub> x 64	13.5
0	1	1	T <sub>convert</sub> x 128	6.7
1	0	0	T <sub>convert</sub> x 256	3.4
1	0	1	T <sub>convert</sub> x 512	1.7
1	1	0	T <sub>convert</sub> x 1024	0.9
1	1	1	T <sub>convert</sub> x 2048	0.4

Bits	Name	Description
7:5	Cycle Time	Configures Automatic Conversion mode. When these bits are set to zeros, the automatic
		conversion mode is disabled. This is the case at power-up.
		When these bits are set to a non-zero value, the ADC will begin operating in automatic conversion
		mode. (See Section 1.9). The Cycle Time table shows how different values provide various
		conversion intervals.
4	Alert Hold	0: Alerts will self-clear when the measured voltage moves within the limits by more than the
		hysteresis register value.
		1: Alerts will not self-clear and are only cleared when a one is written to the alert high flag or the
		alert low flag in the Alert Status register.
3	Alert Flag Enable	0: Disables alert status bit [D15] in the Conversion Result register.
		1: Enables alert status bit [D15] in the Conversion Result register.
2	Alert Pin Enable	0: Disables the ALERT output pin. The ALERT output will TRI-STATE when the pin is disabled.
		1: Enables the ALERT output pin.
		*This bit does not apply to the ADC081C027.
1	Reserved	Always reads zeros. Zeros must be written to these bits.
0	Polarity	This bit configures the active level polarity of the ALERT output pin.
		0: Sets the ALERT pin to active low.
		1: Sets the ALERT pin to active high.
		*This bit does not apply to the ADC081C027.

# 1.6.5 V<sub>LOW</sub> -- Alert Limit Register - Under Range

Pointer Address 03h (Read/Write)

Default Value: 0000h

D15	D14	D13	D12	D11	D10	D9	D8	
Reserved				V <sub>LOW</sub> Limit[7:4]				
D7	D6	D5	D4	D3	D2	D1	D0	
V <sub>LOW</sub> Limit[3:0]				Reserved				

Bits	Name	Description
15:12	Reserved	Always reads zeros. Zeros must be written to these bits.
11:4	LOW	Sets the lower limit threshold used to determine the alert condition. If the conversion moves lower than this limit, a $V_{LOW}$ alert is generated.
3:0	Reserved	Always reads zeros. Zeros must be written to these bits.

### 1.6.6 V<sub>HIGH</sub> -- Alert Limit Register - Over Range Pointer Address 04h (Read/Write) Default Value: 0FFFh D10 D9 D8 D15 D14 D13 D12 D11 V<sub>HIGH</sub> Limit[7:4] Reserved D6 D5 D4 D2 D1 D0 D7 D3 V<sub>HIGH</sub> Limit[3:0] Reserved

Bits	Name	Description
15:12	Reserved	Always reads zeros. Zeros must be written to these bits.
11:4	V <sub>HIGH</sub> Limit	Sets the upper limit threshold used to determine the alert condition. If the conversion moves higher than this limit, a $V_{HIGH}$ alert is generated.
3:0	Reserved	Always reads zeros. Zeros must be written to these bits.

### 1.6.7 V<sub>HYST</sub> -- Alert Hysteresis Register

Hysteresis[3:0]

Pointer Address 05h (Read/Write)

Default Value: 0000h

D15	D14	D13	D12	D11	D10	D9	D8	
	Rese	erved		Hysteresis[7:4]				
D7	D6	D5	D4	D3	D2	D1	D0	

Reserved

Bits	Name	Description
15:12	Reserved	Always reads zeros. Zeros must be written to these bits.
11:4	Hysteresis	Sets the hysteresis value used to determine the alert condition. After a $V_{HIGH}$ or $V_{LOW}$ alert occurs, the conversion result must move within the $V_{HIGH}$ or $V_{LOW}$ limit by more than this value to clear the alert condition. Note: If the Alert Hold bit is set in the configuration register, alert conditions will not self-clear.
3:0	Reserved	Always reads zeros. Zeros must be written to these bits.

## 1.6.8 V<sub>MIN</sub> -- Lowest Conversion Register

Pointer Address 06h (Read/Write)

Default Value: 0FFFh

D15         D14         D13         D12         D11         D10         D9         D8							D8
	Rese	erved	-		Lowest Con	version[7:4]	
D7	De	DE	D4	D2	<b>D</b> 2	D1	DO

D7	D6	D5	D4	D3	D2	D1	D0
	Lowest Con	version[3:0]	-	Reserved			

Bits	Name	Description			
15:12	Reserved	Always reads zeros. Zeros must be written to these bits.			
11:4	Lowest Conversion	Contains the Lowest Conversion result. Each conversion result is compared against the contents of this register. If the value is lower, it becomes the lowest conversion and replaces the current value. If the value is higher, the register contents remain unchanged. The lowest conversion value can be cleared at any time by writting 0FFFh to this register. The value of this register will update automatically when the automatic conversion mode is enabled.			
3:0	Reserved	Always reads zeros. Zeros must be written to these bits.			

# 1.6.9 V<sub>MAX</sub> -- Highest Conversion Register

Pointer Address 07h (Read/Write)

Default Value: 0000h

	D15	D14	D14 D13	D12	D11	D10	D9	D8
Reserved Highest Conversion[7:4]		Rese	Reserved			Highest Cor	version[7:4]	

D7	D6	D5	D4	D3	D2	D1	D0	
	Highest Cor	version[3:0]		Reserved				

Bits	Name	Description
15:12	Reserved	Always reads zeros. Zeros must be written to these bits.
11:4	Highest Conversion	Contains the Highest Conversion result. Each conversion result is compared against the contents of this register. If the value is higher, it becomes the highest conversion and replaces the previous value. If the value is lower, the register contents remain unchanged. The highest conversion value can be cleared at any time by writting 0000h to this register. The value of this register will update automatically when the automatic conversion mode is enabled.
3:0	Reserved	Always reads zeros. Zeros must be written to these bits.

### **1.7 SERIAL INTERFACE**

The I<sup>2</sup>C-compatible interface operates in all three speed modes. Standard mode (100kHz) and Fast mode (400kHz) are functionally the same and will be referred to as Standard-Fast mode in this document. High-Speed mode (3.4MHz) is an extension of Standard-Fast mode and will be referred to as Hs-mode in this document. The following diagrams describe the timing relationships of the clock (SCL) and data (SDA) signals. Pull-up resistors or current sources are required on the SCL and SDA busses to pull them high when they are not being driven low. A logic zero is transmitted by driving the output low. A logic high is transmitted by releasing the output and allowing it to be pulled-up externally. The appropriate pull-up resistor values will depend upon the total bus capacitance and operating speed. The ADC081C021 offers extended ESD tolerance (8kV HBM) for the I2C bus pins (SCL & SDA) allowing extension of the bus across multiple boards without extra ESD protection.

### 1.7.1 Basic I<sup>2</sup>C Protocol

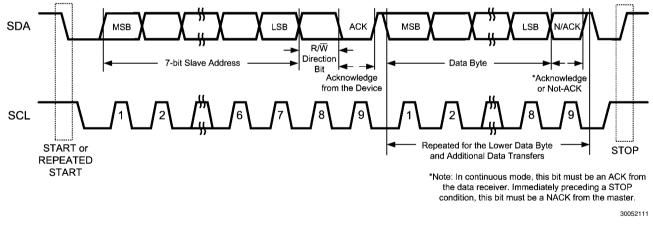
The I<sup>2</sup>C interface is bi-directional and allows multiple devices to operate on the same bus. The bus consists of master devices and slave devices which can communicate back and forth over the I<sup>2</sup>C interface. Master devices control the bus and are typically microcontrollers, FPGAs, DSPs, or other digital controllers. Slave devices are controlled by a master and are typically peripheral devices such as the ADC081C021. To support multiple devices on the same bus, each slave has a unique hardware address which is referred to as the "slave address." To communicate with a particular device on the bus, the controller (master) sends the slave address and listens for a response from the slave. This response is referred to as an acknowledge bit. If a slave on the bus is addressed correctly, it Acknowledges(ACKs) the master by

driving the SDA bus low. If the address doesn't match a device's slave address, it Not-acknowledges(NACKs) the master by letting SDA be pulled high. ACKs also occur on the bus when data is being transmitted. When the master is writing data, the slave ACKs after every data byte is successfully received. When the master is reading data, the master ACKs after every data byte is received to let the slave know it wants to receive another data byte. When the master wants to stop reading, it NACKs after the last data byte and creates a stop condition on the bus.

All communication on the bus begins with either a Start condition or a Repeated Start condition. The protocol for starting the bus varies between Standard-Fast mode and Hs-mode. Standard-Fast mode, the master generates a In Start condition by driving SDA from high to low while SCL is high. In Hs-mode, starting the bus is more complicated. Please refer to section 1.7.3 for the full details of a Hs-mode Start condition. A Repeated Start is generated to address a different device or register, or to switch between read and write modes. The master generates a Repeated Start condition by driving SDA low while SCL is high. Following the Repeated Start, the master sends out the slave address and a read/write bit as shown in Figure 7. The bus continues to operate in the same speed mode as before the Repeated Start condition.

All communication on the bus ends with a Stop condition. In either Standard-Fast mode or Hs-Mode, a Stop condition occurs when SDA is pulled from low to high while SCL is high. After a Stop condition, the bus remains idle until a master generates a Start condition.

Please refer to the Philips  $I2C^{\otimes}$  Specification (Version 2.1 Jan, 2000) for a detailed description of the serial interface.



### FIGURE 7. Basic Operation.

### 1.7.2 Standard-Fast Mode

In Standard-Fast mode, the master generates a start condition by driving SDA from high to low while SCL is high. The start condition is always followed by a 7-bit slave address and a Read/Write bit. After these 8 bits have been transmitted by the master, SDA is released by the master and the ADC081C021 either ACKs or NACKs the address. If the slave address matches, the ADC081C021 ACKs the master. If the address doesn't match, the ADC081C021 NACKs the master. For a **write** operation, the master follows the ACK by sending the 8-bit register address pointer to the ADC. Then the

ADC081C021 ACKs the transfer by driving SDA low. Next,

the master sends the upper 8-bits to the ADC081C021. Then the ADC081C021 ACKs the transfer by driving SDA low. For a single byte transfer, the master should generate a stop condition at this point. For a 2-byte write operation, the lower 8bits are sent by the master. The ADC081C021 then ACKs the transfer, and the master either sends another pair of data bytes, generates a Repeated Start condition to read or write another register, or generates a Stop condition to end communication.

A **read** operation can take place either of two ways:

If the address pointer is pre-set before the read operation, the desired register can be read immediately following the slave

address. In this case, the upper 8-bits of the register, set by the pre-set address pointer, are sent out by the ADC. For a single byte read operation, the Master sends a NACK to the ADC and generates a Stop condition to end communication after receiving 8-bits of data. For a 2-Byte read operation, the Master continues the transmission by sending an ACK to the ADC. Then, the ADC sends out the lower 8-bits of the ADC register. At this point, the master either sends; an ACK to receive more data or, a NACK followed by a Stop or Repeated Start. If the master sends an ACK, the ADC sends the next upper data byte, and the read cycle repeats.

If the address pointer needs to be set, the ADC081C021 needs to write to the device and set the address pointer before reading from the desired register. This type of read requires a start, the slave address, a write bit, the address pointer, a Repeated Start, the slave address, and a read bit (refer to *Figure 12*). Following this sequence, the ADC sends out the upper 8-bits of the register. For a single byte read operation, the Master must send a NACK to the ADC and generate a Stop condition to end communication. For a 2-Byte write operation, the Master sends an ACK to the ADC. Then, the ADC sends out the lower 8-bits of the ADC register. At this point, the master sends either an ACK to receive more data, or a NACK followed by a Stop or Repeated Start. If the master sends an ACK, the ADC sends and the register sends an ACK, the ADC sends and the sends an ACK to the ADC sends out the lower 8-bits of the address the sender sends an ACK to receive more data, or a NACK followed by a Stop or Repeated Start. If the master sends an ACK, the ADC sends another pair of data bytes, and

the read cycle will repeat. The number of data words that can be read is unlimited.

### 1.7.3 High-Speed (Hs) Mode

For Hs-mode, the sequence of events to begin communication differs slightly from Standard-Fast mode. *Figure 8* describes this in further detail. Initially, the bus begins running in Standard-Fast mode. The master generates a Start condition and sends the 8-bit Hs master code (00001XXX) to the ADC081C021. Next, the ADC081C021 responds with a NACK. Once the SCL line has been pulled to a high level, the master switches to Hs-mode by increasing the bus speed and generating a Repeated Start condition (driving SDA low while SCL is pulled high). At this point, the master sends the slave address to the ADC081C021, and communication continues as shown above in the "Basic Operation" Diagram (see *Figure 7*).

When the master generates a Repeated Start condition while in Hs-mode, the bus stays in Hs-mode awaiting the slave address from the master. The bus continues to run in Hs-mode until a Stop condition is generated by the master. When the master generates a Stop condition on the bus, the bus must be started in Standard-Fast mode again before increasing the bus speed and switching to Hs-mode.

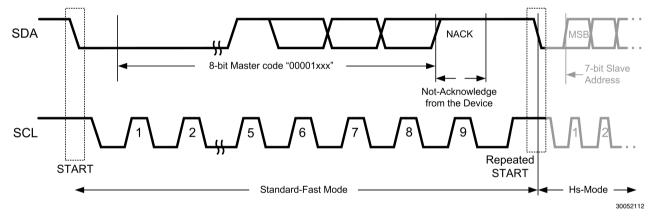


FIGURE 8. Beginning Hs-Mode Communication

### 1.7.4 I<sup>2</sup>C Slave (Hardware) Address

The ADC has a seven-bit hardware address which is also referred to as a slave address. For the ADC081C027, the address is configured by the ADDR address selection input. ADDR can be grounded, left floating, or tied to  $V_A$ . If desired, ADDR can be set to  $V_A/2$  rather than left floating. The state of the ADDR input sets the hardware address that the ADC responds to on the l<sup>2</sup>C bus (see ). For the ADC081C021, the hardware address is not pin-configurable and is set to 1010100. The diagrams in Section 1.10 describe how the l<sup>2</sup>C controller should address the ADC via the l<sup>2</sup>C interface.

### **TABLE 1. Slave Addresses**

Slave Address	ADC081C027*	ADC081C021*
[A6 - A0]	ADDR	ADC001C021
1010000	Floating	
1010001	GND	
1010010	V <sub>A</sub>	
1010100		Single Address
1010101		
1010110		
1011000		
1011001		
1011010		

\* Pin-compatible alternatives to the ADC081C021 and the ADC081C027 are available with additional address options.

### **1.8 ALERT FUNCTION**

The ALERT function is an "out-of-range" indicator. At the end of every conversion, the measured voltage is compared to the values in the V<sub>HIGH</sub> and V<sub>LOW</sub> registers. If the measured voltage exceeds the value stored in V<sub>HIGH</sub> or falls below the value stored in VIOW, an alert condition occurs. The Alert condition is indicated in up to three places. First, the alert condition always causes either or both of the alert flags in the Alert Status register to go high. If the measured voltage exceeds the V<sub>HIGH</sub> limit, the Over Range Alert Flag is set. If the measured voltage falls below the V<sub>LOW</sub> limit, the Under Range Alert Flag is set. Second, if the Alert Flag Enable bit is set in the Configuration register, the alert condition also sets the MSB of the Conversion Result register. Third, if the Alert Pin Enable bit is set in the Configuration register, the ALERT output becomes active (see Figure 9). The ALERT output can be configured as an active high or active low output via the Polarity bit in the Configuration register. If the Polarity bit is cleared, the ALERT output is configured as active low. If the Polarity bit is set, the ALERT output is configured as active high.

The Over Range Alert condition is cleared when one of the following two conditions is met:

- 1. The controller writes a one to the Over Range Alert Flag bit.
- The measured voltage reduces below the programmed V<sub>HIGH</sub> limit minus the programmed V<sub>HYST</sub> value and the Alert Hold bit is cleared in the Configuration register. (see *Figure 9*). If the Alert Hold bit is set, the alert condition persists and only clears when a one is written to the Over Range Alert Flag bit.

The Under Range Alert condition is cleared when one of the following two conditions is met:

- 1. The controller writes a one to the Under Range Alert Flag bit.
- 2. The measured voltage increases above the programmed  $V_{LOW}$  limit plus the programmed  $V_{HYST}$  value and the Alert Hold bit is cleared in the Configuration register. If the Alert Hold bit is set, the alert condition persists and only clears when a one is written to the Under Range Alert Flag bit.

If the alert condition has been cleared by writing a one to the alert flag while the measured voltage still violates the  $V_{HIGH}$  or  $V_{LOW}$  limits, an alert condition will occur again after the completion of the next conversion (see *Figure 10*).

Alert conditions only occur if the input voltage exceeds the V<sub>HIGH</sub> limit or falls below the V<sub>LOW</sub> limit at the sample-hold instant. The input voltage can exceed the V<sub>HIGH</sub> limit or fall below the V<sub>LOW</sub> limit briefly between conversions without causing an alert condition.

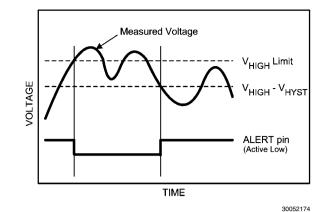


FIGURE 9. Alert condition cleared when measured voltage crosses V<sub>HIGH</sub> - V<sub>HYST</sub>

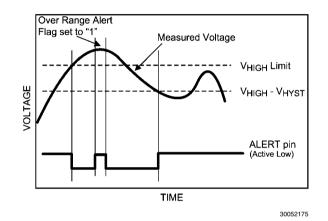


FIGURE 10. Alert condition cleared by writing a "1" to the Alert Flag.

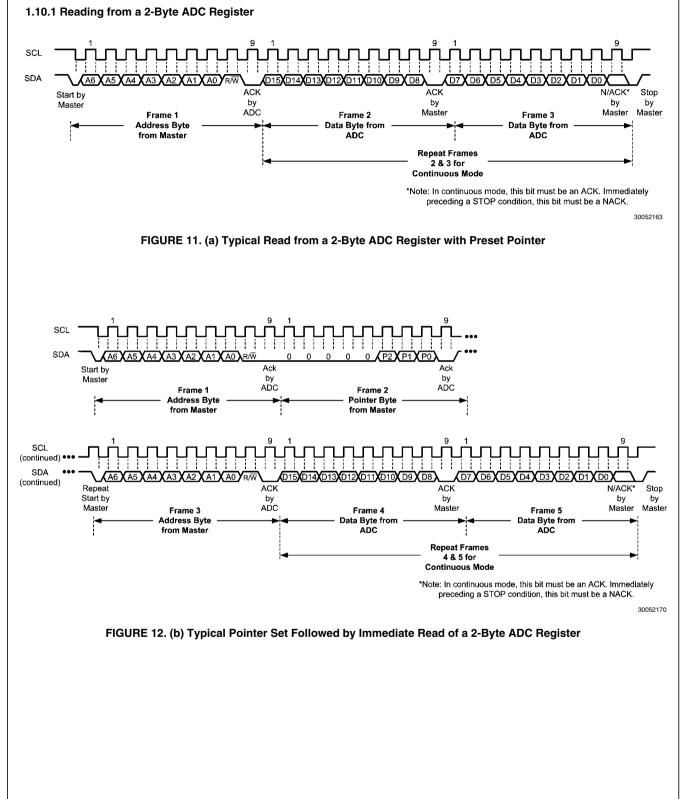
### **1.9 AUTOMATIC CONVERSION MODE**

The automatic conversion mode configures the ADC to continually perform conversions without receiving "read" instructions from the controller over the I<sup>2</sup>C interface. The mode is activated by writing a non-zero value into the Cycle Time bits - D[7:5] - of the configuration register (see section 1.6.4). Once the ADC081C021 enters this mode, the internal oscillator is always enabled. The ADC's control logic samples the input at the sample rate set by the cycle time bits. Although the conversion result is not transmitted by the 2-wire interface, it is stored in the conversion result register and updates the various status registers of the device.

In automatic conversion mode, the out-of-range alert function is active and updates after every conversion. The ADC can operate independently of the controller in automatic conversion mode. When the input signal goes "out-of-range", an alert signal is sent to the controller. The controller can then read the status registers and determine the source of the alert condition. Also, comparison and updating of the V<sub>MIN</sub> and V<sub>MAX</sub> registers occurs after every conversion in automatic conversion mode. The controller can ocassionally read the V<sub>MIN</sub> and/or V<sub>MAX</sub> registers to determine the sampled input extremes. These register values persist until the user resets the V<sub>MIN</sub> and V<sub>MAX</sub> registers. These two features are useful in system monitoring, peak detection, and sensing applications.

### 1.10 COMMUNICATING WITH THE ADC081C021

The ADC081C021's data registers are selected by the address pointer (see Section 1.6.1). To read/write a specific data register, the pointer must be set to that register's address. The pointer is always written at the beginning of a write operation. When the pointer needs to be updated for a read cycle, a write operation must preceed the read operation to set the pointer address correctly. On the other hand, if the pointer is preset correctly, a read operation can occur without writing the address pointer register. The following timing diagrams describe the various read and write operations supported by the ADC.



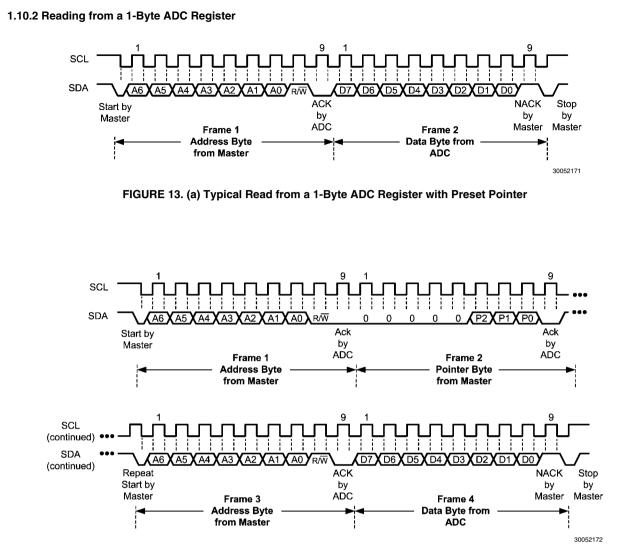
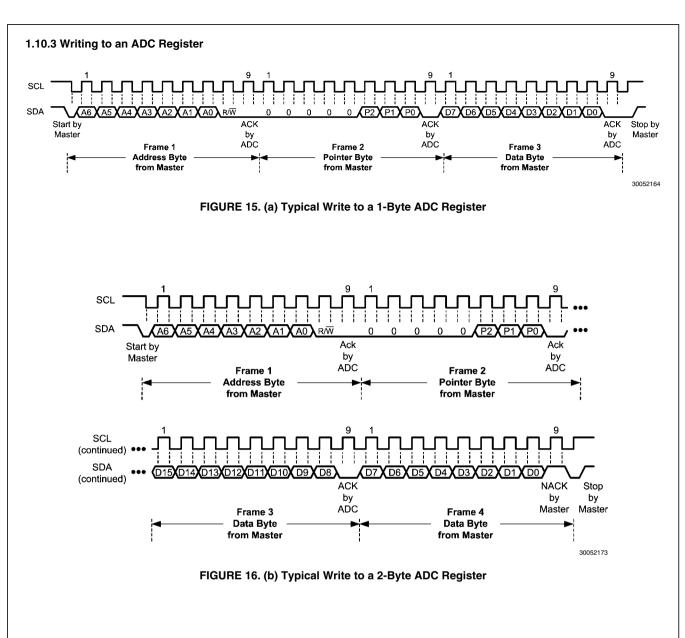


FIGURE 14. (b) Typical Pointer Set Followed by Immediate Read of a 1-Byte ADC Register



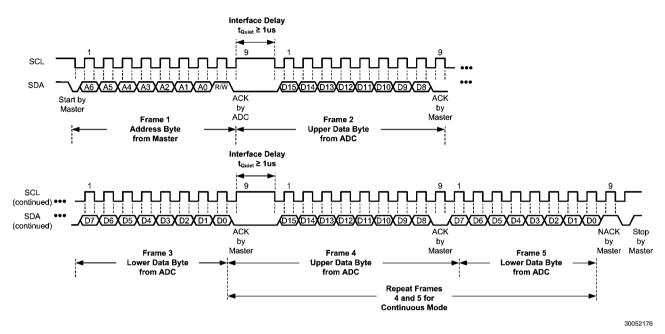


## 1.11 QUIET INTERFACE MODE

To improve performance at High Speed, operate the ADC in Quiet Interface Mode. This mode provides improved INL and DNL performance in I<sup>2</sup>C Hs-Mode (3.4MHz). The Quiet Interface mode provides a maximum throughput rate of 162ksps. *Figure 17* describes how to read the conversion result register in this mode. Basically, the Master needs to release SCL for

at least 1µs before the MSB of every upper data byte. The diagram assumes that the address pointer register is set to its default value.

Quiet Interface mode will only improve INL and DNL performance in Hs-Mode. Standard and Fast mode performance is unaffected by the Quiet Interface mode.





# 2.0 Applications Information

### 2.1 TYPICAL APPLICATION CIRCUIT

A typical application circuit is shown in *Figure 18.* The analog supply is bypassed with a capacitor network located close to the ADC081C021. The ADC uses the analog supply ( $V_A$ ) as its reference voltage, so it is very important that  $V_A$  be kept as clean as possible. Due to the low power requirements of the ADC081C021, it is possible to use a precision reference as a power supply. The pull-up resistors ( $R_P$ ) should be powered by the controller's supply. It is important that the pull-up resistors are pulled to the same voltage potential  $V_A$  is set to. This will ensure that the logic levels of all devices on the bus are compatible. If the controller's supply is noisy, an appro-

priate bypass capacitor should be added between the controller's supply pin and the pull-up resistors. For Hs-mode applications, this bypass capacitance will improve the accuracy of the ADC.

The value of the pull-up resistors (R<sub>p</sub>) depends upon the characteristics of each particular I<sup>2</sup>C bus. The I<sup>2</sup>C specification describes how to choose an appropriate value. As a general rule-of-thumb, we suggest using a 1k $\Omega$  resistor for Hs-mode bus configurations and a 5k $\Omega$  resistor for Standard or Fast Mode bus configurations. Depending upon the bus capacitance, these values may not be sufficient to meet the timing requirements of the I<sup>2</sup>C bus specification. Please see the I<sup>2</sup>C specification for further information.

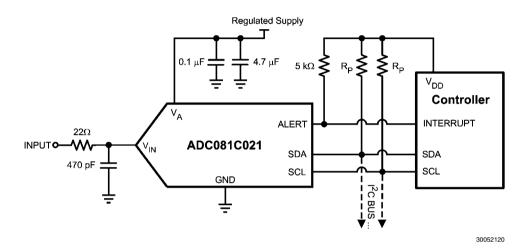


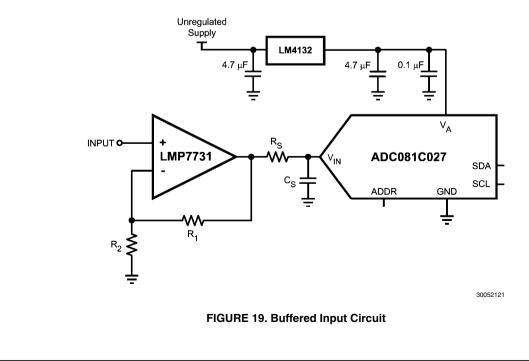
FIGURE 18. Typical Application Circuit

### 2.2 BUFFERED INPUT

A bufferred input application circuit is shown in *Figure 19*. The analog input is buffered by National's LMP7731. The non-inverting amplifier configuration provides a buffered gain stage for a single ended source. This application circuit is good for

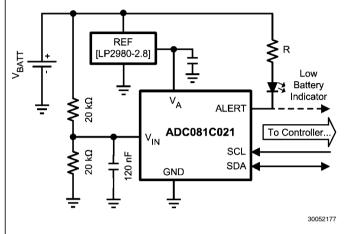
single-ended sensor interface. The input must have a DC bias level that keeps the ADC input signal from swinging below GND or above the supply (+5V in this case).

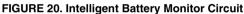
The LM4132, with its 0.05% accuracy over temperature, is an excelent choice as a reference source for the ADC081C021.



### 2.3 INTELLIGENT BATTERY MONITOR

The ADC081C021 is easily used as an intelligent battery monitor. The simple circuit shown in *Figure 20*, uses the ADC081C021, the LP2980 fixed reference, and a resistor divider to implement an intelligent battery monitor with a window supervisory feature. The window supervisory feature is implemented by the "out of range" alert function. When the battery is recharging, the Over Range Alert will indicate that the charging cycle is complete (see *Figure 21*). When the battery is nearing depletion, the Under Range Alert will indicate that the battery is low (see *Figure 22*).





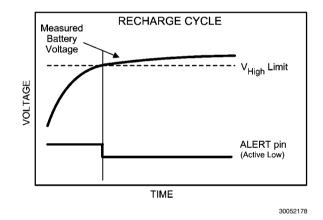
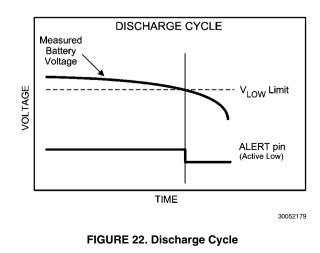


FIGURE 21. Recharge Cycle

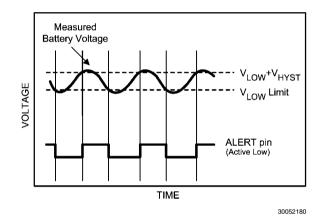


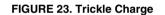
In addition to the window supervisory feature, the ADC081C021 will allow the controller to read the battery voltage at any time during operation. Reading the conversion result via the I<sup>2</sup>C interface provides an accurate voltage reading.

The accurate voltage reading and the alert feature will allow a controller to improve the efficiency of a battery-powered device. During the discharge cycle, the controller can switch to a low-battery mode, safely suspend operation, or report a precise battery level to the user. During the recharge cycle, the controller can implement an intelligent recharge cycle, decreasing the charge rate when the battery charge nears capacity.

### 2.3.1 Trickle Charge Controller

While a battery is discharging, the ADC081C021 can be used to control a trickle charge to keep the battery near full capacity (see *Figure 23*). When the alert output is active, the battery will recharge. An intelligent recharge cycle will prevent overcharging and damaging the battery. With a trickle charge, the battery powered device can be disconnected from the charger at any time with a full charge.



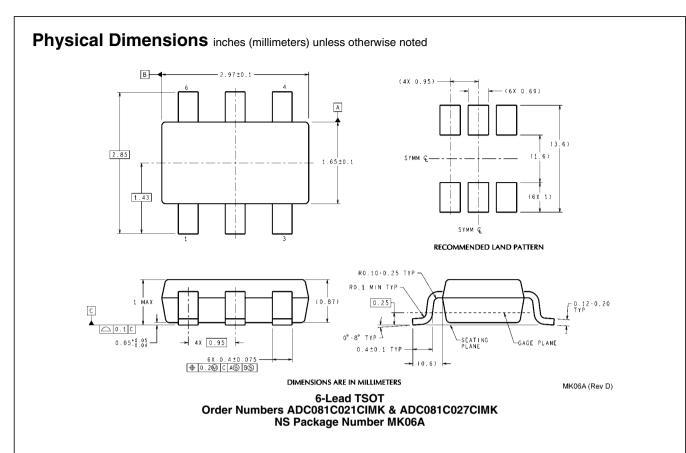


### 2.4 LAYOUT, GROUNDING, AND BYPASSING

For best accuracy and minimum noise, the printed circuit board containing the ADC081C021 should have separate analog and digital areas. The areas are defined by the locations of the analog and digital power planes. Both of these planes should be located on the same board layer. There should be a single ground plane. A single, solid ground plane is preferred if digital return current does not flow through the analog ground area. Frequently a single ground plane design will utilize a "fencing" technique to prevent the mixing of analog and digital ground current. Separate ground planes should only be utilized when the fencing technique is inadequate. The separate ground planes must be connected in one place, preferably near the ADC081C021. Special care is required to guarantee that signals do not pass over power plane boundaries. They must always have a continuous return path below their traces.

The ADC081C021 power supply should be bypassed with a  $4.7\mu$ F and a  $0.1\mu$ F capacitor as close as possible to the device with the  $0.1\mu$ F right at the device supply pin. The  $4.7\mu$ F capacitor should be a tantalum type and the  $0.1\mu$ F capacitor should be a low ESL type. The power supply for the ADC081C021 should only be used for analog circuits.

Avoid crossover of analog and digital signals and keep the clock and data lines on the component side of the board. The clock and data lines should have controlled impedances.



# Notes

**Design Support** 

For more National Semiconduc	tor proc				
Products					
Amplifiers	www.n				
Audio	www.n				
Clock Conditioners	www.n				
Data Converters	www.n				
Displays	www.n				
Ethernet	www.n				
Interface	www.n				
LVDS	www.n				
Power Management	www.n				
Switching Regulators	www.n				
LDOs	www.n				
LED Lighting	www.n				
PowerWise	www.n				
Serial Digital Interface (SDI)	www.n				
Temperature Sensors	www.n				
Wireless (PLL/VCO)	www.n				
("NATIONAL") PRODUCTS. NATOR COMPLETENESS OF THE SPECIFICATIONS AND PROD IMPLIED, ARISING BY ESTOF DOCUMENT. TESTING AND OTHER QUALI NATIONAL'S PRODUCT WARF PARAMETERS OF EACH PF APPLICATIONS ASSISTANCE APPLICATIONS USING NATIO NATIONAL COMPONENTS, BU EXCEPT AS PROVIDED IN NAT LIABILITY WHATSOEVER, AN AND/OR USE OF NATIONAL PF	FIONAL I CONTI UCT DE PPEL OF TY CON RANTY. RODUCT OR BU NAL CO YERS S FIONAL'S D NATIG RODUCT				
SYSTEMS WITHOUT THE EX COUNSEL OF NATIONAL SEM Life support devices or systems whose failure to perform when pr to result in a significant injury to th can be reasonably expected to construct National Semiconductor and the	PRESS ICONDU are devis operly us ne user. A ause the National				
	Amplifiers         Audio         Clock Conditioners         Data Converters         Displays         Ethernet         Interface         LVDS         Power Management         Switching Regulators         LDOs         LED Lighting         PowerWise         Serial Digital Interface (SDI)         Temperature Sensors         Wireless (PLL/VCO)         THE CONTENTS OF THIS DOC ("NATIONAL") PRODUCTS. NATOR COMPLETENESS OF THE SPECIFICATIONS AND PROD IMPLIED, ARISING BY ESTOF DOCUMENT.         TESTING AND OTHER QUALI NATIONAL'S PRODUCT WARF PARAMETERS OF EACH PF APPLICATIONS USING NATION NATIONAL COMPONENTS, BU EXCEPT AS PROVIDED IN NAT LIABILITY WHATSOEVER, AN AND/OR USE OF NATIONAL PF PURPOSE, MERCHANTABILIT RIGHT.				

### For more National Semiconductor product information and proven design tools, visit the following Web sites at:

Amplifiers	www.national.com/amplifiers	WEBENCH	www.national.com/webench
Audio	www.national.com/audio	Analog University	www.national.com/AU
Clock Conditioners	www.national.com/timing	App Notes	www.national.com/appnotes
Data Converters	www.national.com/adc	Distributors	www.national.com/contacts
Displays	www.national.com/displays	Green Compliance	www.national.com/quality/green
Ethernet	www.national.com/ethernet	Packaging	www.national.com/packaging
Interface	www.national.com/interface	Quality and Reliability	www.national.com/quality
LVDS	www.national.com/lvds	Reference Designs	www.national.com/refdesigns
Power Management	www.national.com/power	Feedback	www.national.com/feedback
Switching Regulators	www.national.com/switchers		
LDOs	www.national.com/ldo		
LED Lighting	www.national.com/led		
PowerWise	www.national.com/powerwise		
Serial Digital Interface (SDI)	www.national.com/sdi		
Temperature Sensors	www.national.com/tempsensors		
Wireless (PLL/VCO)	www.national.com/wireless		

THE CONTENTS OF THIS DOCUMENT ARE PROVIDED IN CONNECTION WITH NATIONAL SEMICONDUCTOR CORPORATION ("NATIONAL") PRODUCTS. NATIONAL MAKES NO REPRESENTATIONS OR WARRANTIES WITH RESPECT TO THE ACCURACY OR COMPLETENESS OF THE CONTENTS OF THIS PUBLICATION AND RESERVES THE RIGHT TO MAKE CHANGES TO SPECIFICATIONS AND PRODUCT DESCRIPTIONS AT ANY TIME WITHOUT NOTICE. NO LICENSE, WHETHER EXPRESS, IMPLIED, ARISING BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT.

TESTING AND OTHER QUALITY CONTROLS ARE USED TO THE EXTENT NATIONAL DEEMS NECESSARY TO SUPPORT NATIONAL'S PRODUCT WARRANTY. EXCEPT WHERE MANDATED BY GOVERNMENT REQUIREMENTS, TESTING OF ALL PARAMETERS OF EACH PRODUCT IS NOT NECESSARILY PERFORMED. NATIONAL ASSUMES NO LIABILITY FOR APPLICATIONS ASSISTANCE OR BUYER PRODUCT DESIGN. BUYERS ARE RESPONSIBLE FOR THEIR PRODUCTS AND APPLICATIONS USING NATIONAL COMPONENTS. PRIOR TO USING OR DISTRIBUTING ANY PRODUCTS THAT INCLUDE NATIONAL COMPONENTS, BUYERS SHOULD PROVIDE ADEQUATE DESIGN, TESTING AND OPERATING SAFEGUARDS.

EXCEPT AS PROVIDED IN NATIONAL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, NATIONAL ASSUMES NO LIABILITY WHATSOEVER, AND NATIONAL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY RELATING TO THE SALE AND/OR USE OF NATIONAL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS PRIOR WRITTEN APPROVAL OF THE CHIEF EXECUTIVE OFFICER AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

Life support devices or systems are devices which (a) are intended for surgical implant into the body, or (b) support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in a significant injury to the user. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system or to affect its safety or effectiveness.

National Semiconductor and the National Semiconductor logo are registered trademarks of National Semiconductor Corporation. All other brand or product names may be trademarks or registered trademarks of their respective holders.

### Copyright© 2008 National Semiconductor Corporation

For the most current product information visit us at www.national.com



ADC081C(

National Semiconductor Americas Technical Support Center Email: support@nsc.com Tel: 1-800-272-9959 National Semiconductor Europe Technical Support Center Email: europe.support@nsc.com German Tel: +49 (0) 180 5010 771 English Tel: +44 (0) 870 850 4288 National Semiconductor Asia Pacific Technical Support Center Email: ap.support@nsc.com National Semiconductor Japan Technical Support Center Email: jpn.feedback@nsc.com